

Features

- 3528 Top view PLCC SMD LED
- High reliability
- General purpose leads
- Peak wavelength λp=850nm
- Mechanically and spectrally matched to the phototransistor
- Low forward voltage
- High radiant intensity

Applications

- Optoelectronic Switch
- IR Touch-Panel
- Industrial IR Equipment
- Consumer Electronics
- High Speed IR Communications

Description

The IN-P32ZTIR is a popular 3528 top view package with versatile design capabilities. It is a PLCC type LED which can be used in various applications.

Recommended Solder Pattern

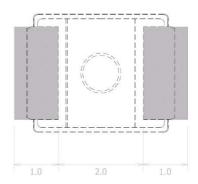
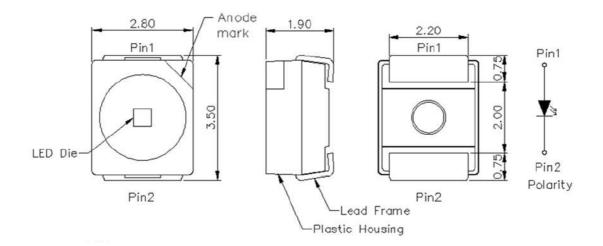


Figure 1. IN-P32ZTIR Solder Pattern

Package Dimensions in mm



Notes.

- 1. All dimensions are in millimeters.
- 2. Tolerance is ± 0.10 mm unless otherwise noted

Figure 2. IN-P32ZTIR Package Dimensions



Absolute Maximum Rating at 25°C (Note 1)

Product	Emission Color	P _d (mW)	I _F (mA)	I _{FP} * (mA)	V _R (V)	Top (°C)	T _{ST} (°C)
IN-P32ZTIR	Infrared	165	100	1000	5	-40°C~+85°C	-40°C~+100°C

Notes

1. IFP Conditions--Pulse Width $\leq\!100\mu s$ and Duty $\leq\!1\%.$

ESD Precaution

ATTENTION: Electrostatic Discharge (ESD) protection



The symbol above denotes that ESD precaution is needed. ESD protection for GaP and AlGaAs based chips is necessary even though they are relatively safe in the presence of low static-electric discharge. Parts built with AlInGaP, GaN, or/and InGaN based chips are STATIC SENSITIVE devices. ESD precaution must be taken during design and assembly.

If manual work or processing is needed, please ensure the device is adequately protected from ESD during the process.

Please be advised that normal static precautions should be taken in the handling and assembly of this device to prevent damage or degradation which may be induced by electrostatic discharge (ESD).

Electrical Characteristics $T_A = 25\%$ (Note 1)

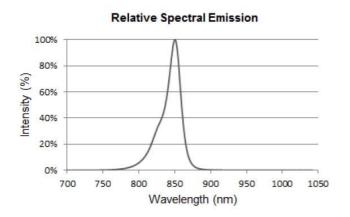
			V _F (V)		λ(nm)			Viewing Angle	le (mW/sr)
Product	Emission Color	I _F (mA)	min	max	λD	λ _P	Δλ	201/2	typ.
IN-P32ZTIR	Infrared	20	1.35	1.65	-	850	30	120	4.5

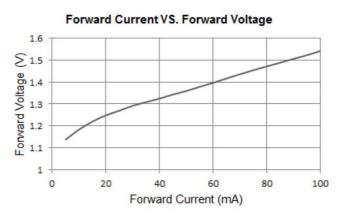
Notes

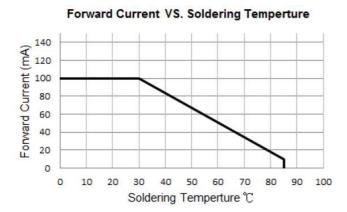
1. Performance guaranteed only under conditions listed in above tables.

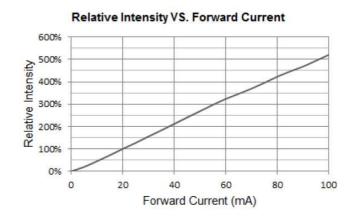


Typical Characteristic Curves

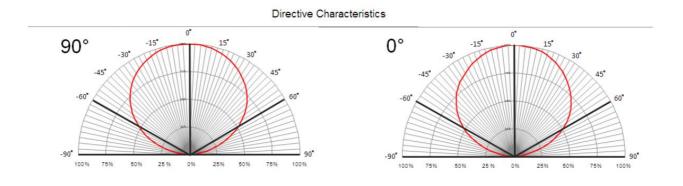








Typical Characteristic Curves – Radiation Pattern

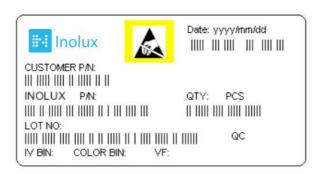




Ordering Information

Product	Emission Color	Technology	Test Current I _F (mA)	Radiant Intensity le (mW/sr) (Typ.)	Forward Voltage V _F (V) (Typ.)	Orderable Part Number
IN-P32ZTIR	Infrared	AlGaAs	20	4.5	1.5	IN-P32ZTIR

Label Specifications



Inolux P/N:

I	N	-	Р	32	Z	T			IR	-	Х	Х	Х	Х
			Material	Package	Variation	Orientation	Current	Lens	Color				mizec p-off	
In	olux		P = PLCC Type		28 1.9mm PLCC 2	T = Top Mount	(Blank) = 20mA	(Blank) = clear	IR = 850nm					

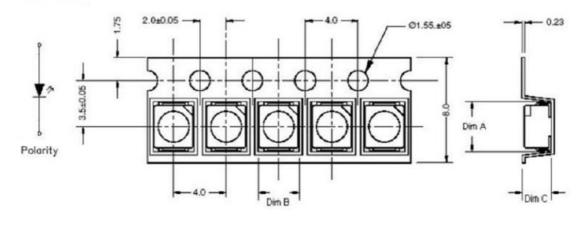
Lot No.:

Z	2	0	1	7	01	24	001
Internal		Voor (2017	2019 \	Month	Data	Serial	
Tracker		Year (2017	, 2016,)	IVIOITUI	Date	Seriai	



Packaging Information: 2000pcs Per Reel

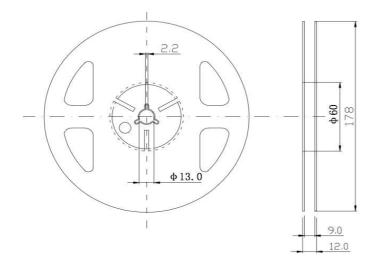
Packaging Tape Dimension

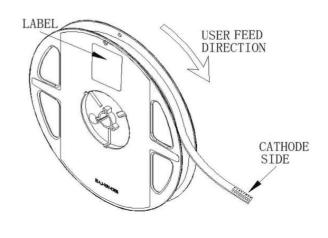


Dim. A	Dim. B	Dim. C	Q'ty/Reel
3.73±0.10	2.95±0.10	2.12±0.10	2K

Unit: mm

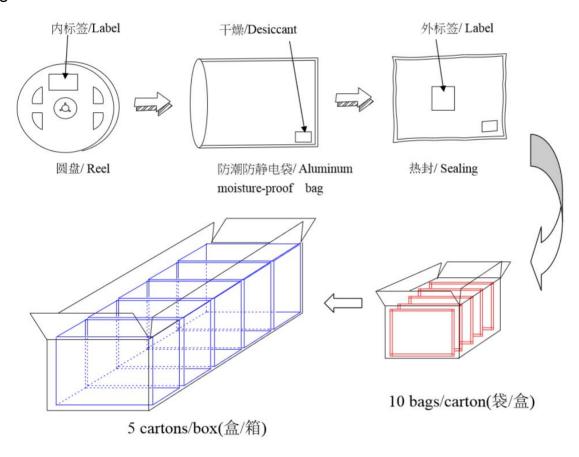
Reel Dimension







Packing Dimension



5 boxes per carton are available depending on shipment quantity.

	Specification	Material	Quantity
Carrier tape	Per EIA 481-1A specs	Conductive black tape	2000pcs per reel
Reel	Per EIA 481-1A specs	Conductive black	
Label	IN standard	Paper	
Packing bag	220x240mm	Aluminum laminated bag/ no-zipper	One reel per bag
Carton	IN standard	Paper	Non-specified

Others:

Each immediate box consists of 5 reels. The 5 reels may not necessarily have the same lot number or the same bin combinations of Iv, λ_P and Vf. Each reel has a label identifying its specification; the immediate box consists of a product label as well.

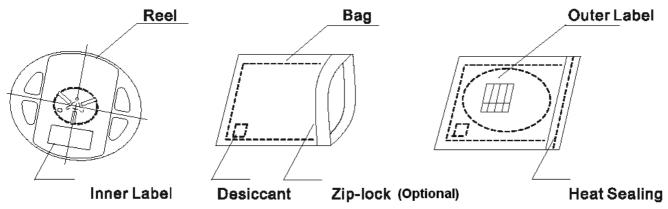


Dry Pack

All SMD optical devices are **MOISTURE SENSITIVE**. Avoid exposure to moisture at all times during transportation or storage. Every reel is packaged in a moisture protected anti-static bag. Each bag is properly sealed prior to shipment.

Upon request, a humidity indicator will be included in the moisture protected anti-static bag prior to shipment.

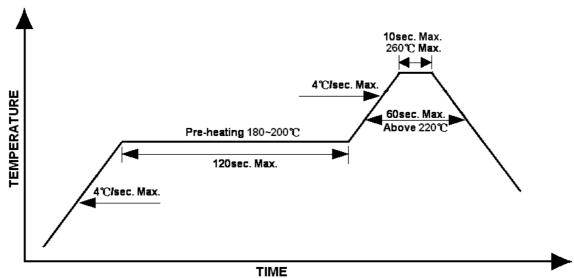
The packaging sequence is as follows:



Reflow Soldering

- Recommended tin glue specifications: melting temperature in the range of 178~192 °C
- The recommended reflow soldering profile is as follows (temperatures indicated are as measured on the surface of the LED resin):

Lead-free Solder Profile





Precautions

- Avoid exposure to moisture at all times during transportation or storage.
- Anti-Static precaution must be taken when handling GaN, InGaN, and AllnGaP products.
- It is suggested to connect the unit with a current limiting resistor of the proper size. Avoid applying a reverse voltage.
- Avoid operation beyond the limits as specified by the absolute maximum ratings.
- Avoid direct contact with the surface through which the LED emits light.
- If possible, assemble the unit in a clean room or dust-free environment.

Reworking

- Rework should be completed within 5 seconds under 260 °C.
- The iron tip must not come in contact with the copper foil.
- Twin-head type is preferred.

Cleaning

Following are cleaning procedures after soldering:

- An alcohol-based solvent such as isopropyl alcohol (IPA) is recommended.
- Temperature x Time should be 50°C x 30sec. or <30°C x 3min
- Ultra sonic cleaning: < 15W/ bath; bath volume ≤ 1liter
- Curing: 100 °C max, <3min

Cautions of Pick and Place

- Avoid stress on the resin at elevated temperature.
- Avoid rubbing or scraping the resin by any object.
- Electro-static may cause damage to the component. Please ensure that the equipment is properly grounded. Use of an ionizer fan is recommended.





Reliability

Item	Frequency/ lots/ samples/	Standards	Conditions		
	failures	Reference			
	For all reliability	J-STD-020	1.) Baking at 85°C for 24hrs		
Precondition	monitoring tests according		2.) Moisture storage at 85°C/60% R.H. for		
	to JEDEC Level 2		168hrs		
	1Q/ 1/ 22/ 0	JESD22-B102-B	Accelerated aging 155°C/ 24hrs		
Solderability		And CNS-5068	Tinning speed: 2.5+0.5cm/s		
			Tinning: A: 215°C/3+1s or B: 260°C/10+1s		
		CNS-5067	Dipping soldering terminal only		
Resistance to			Soldering bath temperature		
soldering heat			A: 260+/-5°C; 10+/-1s		
			B: 350+/-10°C; 3+/-0.5s		
	1Q/ 1/ 40/ 0	CNS-11829	1.) Precondition: 85°C baking for 24hrs		
Operating life test			85°C/ 60%R.H. for 168hrs		
J - F			2.) Tamb25°C; IF=20mA; duration 1000hrs		
High humidity,	1Q/ 1/ 45/ 0	JESD-A101-B	Tamb: 85°C		
high temperature	1 4 17 187 8	0202711012	Humidity: 85% R.H., IF=5mA		
bias			Duration: 1000hrs		
	1Q/ 1/ 20	IN specs.	Tamb: 55°C		
High temperature		'	IF=20mA		
bias			Duration: 1000hrs		
	1Q/ 1/ 40/ 0		Tamb25°C, If=20mA,, Ip=100mA, Duty		
Pulse life test			cycle=0.125 (tp=125 μ s,T=1sec)		
			Duration 500hrs)		
	1Q/ 1/ 76/ 0	JESD-A104-A	A cycle: -40 degree C 15min; +85 degree C		
	1 4, 1, 7 5, 5	IEC 68-2-14, Nb	15min		
Temperature		120 00 2 14, 140	Thermal steady within 5 min		
cycle			300 cycles		
			2 chamber/ Air-to-air type		
High humidity	1Q/ 1/ 40/ 0	CNS-6117	60+3°C		
storage test	1 47 17 107 0	0.10 0117	90+5/-10% R.H. for 500hrs		
High temperature	1Q/ 1/ 40/ 0	CNS-554	100+10°C for 500hrs		
storage test	1 3/ 1/ 40/ 0	0110 007	100110 01010001113		
Low temperature	1Q/ 1/ 40/ 0	CNS-6118	-40+5°C for 500hrs		
storage test	19/1/40/0	0110-0110	7070 0 101 0001113		
Sicrage lesi	1				



Revision History

Changes since last revision	Page	Version No.	Revision Date
Initial Release		1.0	01-29-2019

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- 2. A critical component in any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.